

# 2.4GHZ TRANSMIT / RECEIVE ZIGBEE RFEIC WITH DIVERSITY SWITCH



#### DESCRIPTION

The RFX2411 is a fully integrated, single-chip, single-die RFeIC (RF Front-end Integrated Circuit) which incorporates all the RF functionality needed for wireless ZigBee / smart energy applications. The RFX2411 architecture integrates the PA, LNA, Transmit and Receive switching circuitry, the associated matching network, a harmonic filter and a diversity switch all in a CMOS single-chip device. It also includes a bypass mode to provide maximal level of flexibility for system implementations.

This RFeIC is designed for use in 2.4GHz ISM band and supports the 802.15.4 and ZigBee standard. Typical high power applications include home and industrial automation, smart power, and RF4CE among others. Combining superior performance, high sensitivity and efficiency, low noise, small form factor, and low cost, RFX2411 is the perfect solution for applications requiring extended range and bandwidth. RFX2411 has simple and low-voltage CMOS control logic, and requires minimal external components for system implementation. The PA power detect circuit is also integrated.

#### **FEATURES**

- 2.4GHz ZigBee High Power Single-Chip, Single-Die RF Front-End IC
- Antenna Diversity Switch
- 2.4GHz Transmit High Power Amplifier with Low-Pass Harmonic Filter
- ► Low Noise Amplifier
- ► Transmit/Receive Switch Circuitry
- High Transmit Signal Linearity Meeting Standards for OQPSK Modulation
- Integrated Power Detector for Transmit Power Monitor and Control
- Low Voltage (1.2V) CMOS Control Logic
- ► ESD Protection Circuitry on All Ports
- DC Decoupled RF Ports
- Internal RF Decoupling on All VDD Bias Pins
- Low Noise Figure for the Receive Channel
- Very Low DC Power Consumption

- Full On-chip Matching and Decoupling Circuitry
- Minimal External Components Required
- ► 50-Ohm Input / Output Matching
- Market Proven CMOS Technology
- 3 x 3 x 0.55mm Small Outline QFN-20 Package with Exposed Ground Pad

#### **APPLICATIONS**

- ZigBee Extended Range Devices
- ZigBee Smart Power
- RF4CE Remote Control
- Home and Industrial Automation
- Custom 2.4GHz Radio Systems
- Mobile and Battery ZigBee Systems

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### **PIN ASSIGNMENTS:**

Pin Number	Pin Name	Description
1, 11,13, 19, 21	GND	Ground – Must be connected to Ground in the Application Circuit
2, 4	NC	No Internal Connection
5	TXRX	RF signal to/from the Transceiver: DC shorted to GND
6	TXEN	CMOS Input to Control TX Enable
7	RXEN	CMOS Input to Control RX Enable
8	PDET	Analog Voltage Proportional to the PA Power Output
9	MODE	CMOS Input to control mode of operation
10	SWant	CMOS Input to select antenna for diversity
12	ANTB	RF Signal from the PA or RF Signal Applied to the LNA; DC Shorted to GND
14	ANTA	RF Signal from the PA or RF Signal Applied to the LNA; DC Shorted to GND
15	IND	Inductor to GND
3, 16, 17	DNC	Reserved – Do Not Connect in the Application Circuit
18	VDD1	Voltage Supply Connection
20	VDD2	Voltage Supply Connection

### PIN-OUT DIAGRAM:



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## ABSOLUTE MAXIMUM RATINGS:

Parameters	Units	Min	Max	Conditions
DC VDD Voltage Supply	V	0	4.0	All VDD Pins
DC Control Pin Voltage	V	0	3.6	Through 1Kohm resistor
DC VDD Current Consumption	mA		350	Through VDD Pins when TX is "ON"
TX RF Input Power	dBm		+5	
ANT RF RX Input Power	dBm		+5	
Junction Temperature	°C		+150	
Storage Ambient Temperature	°C	-50	+150	No RF and DC Voltages Applied Appropriate care required according to JEDEC Standards
ESD Voltage (HBM)	V	> 1000		Human Body Model

Note: Sustained operation at or above the Absolute Maximum Ratings for any one or combinations of the above parameters may result in permanent damage to the device and is not recommended.

All Maximum RF Input Power Ratings assume 50-Ohm terminal impedance.

# RECOMENDED OPERATING CONDITIONS:

Parameters	Units	Min	Тур	Max	Conditions
DC VDD Voltage Supply (Note 1)	V	2.0	3.3	3.6	All VDD Pins
Control Voltage "High"	V	1.2		VDD	Through 1Kohm resistor
Control Voltage "Low"	V	0		0.3	
DC Control Pin Current Consumption	μA		1		Mode, SWant, TXEN, RXEN
DC Shutdown Current	μA		1		Mode, SWant, TXEN, RXEN = Low
PA Turn On/Off Time	µsec			1	
LNA Turn On/Off Time	µsec			1	
Antenna Switch Time	µsec			1	
Operating Ambient Temperature	°C	-40		+125	
θја	°C/W		35		See Note 2

Note 1: For normal operation of the RFX2411, VDD must be continuously applied to all VDD supply pins.

Note2: For operation above +85 °C, use the  $\theta$  ia as guidance for system design to assure the junction temperature will not exceed the maximum of +150 °C.

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## TRANSMIT TECHNICAL PARAMETERS (VDD=3.3V; T=+25 °C)

Parameters	Units	Min	Тур	Max	Conditions
Operating Frequency Band	GHz	2.4		2.5	All RF Pins Terminated by 50 Ohm
Saturated Output Power	dBm		+21		
Output P1dB	dBm		+19		CW Input
Small Signal Cain	dB		26		High Idq TX Mode
Small-Signal Gain	dB		24		Low Idq TX Mode
Second Harmonic	dBc		-35		P <sub>OUT</sub> <= +20dBm, CW at ANT Pin
Third Harmonic	dBc		-35		Pout <= +20dBm, CW at ANT Pin
Total Quantu Quarant	mA		95		P <sub>OUT</sub> = +20dBm, High Idq TX Mode
Total Supply Current	mA		95		P <sub>OUT</sub> = +20dBm, Low Idq TX Mode
TX Quiescent Current	mA		18		High Idq TX Mode
TX Quiescent Current	mA		15		Low Idq TX Mode
Input Return Loss	dB		-15		
Output Return Loss	dB		-7		
	V		0.14		Pout = +5dBm, 10kΩ load
Power Detector Voltage	V		0.9		Pout = +20dBm, 10kΩ load
Input / Output Impedance Single-Ended	Ohm		50		
RF Leakage Active Antenna to non-Active Antenna	dB		-18		Antenna A/B leaking into Antenna B/A
Load VSWR for Stability (Set Pout=20dBm at 50 ohm)	N/A		6:1		All Non-Harmonically Related Spurs Less than -60dBm/MHz (CW)
Load VSWR for Ruggedness (Set Pout=20dBm at 50 ohm)	N/A		10:1		No Damage



# RECEIVE TECHNICAL PARAMETERS (VDD=3.3V; T=+25 °C)

Parameters	Units	Min	Тур	Max	Conditions
Operating Frequency Band	GHz	2.4		2.5	All RF Pins Terminated by 50 Ohm
Coin	dD		14		Low Noise Figure Mode
Gain	dB		10		Low Current Mode
Naiaa Figura	dB	Low Noise Figure Mode			
Noise Figure			3.5		Low Current Mode
	alDura		-8		Low Noise Figure Mode
Input P <sub>1dB</sub>	dBm		-3		Low Current Mode
DV Outcocont Oursent			9		Low Noise Figure Mode
RX Quiescent Current	mA		4		Low Current Mode
RF Port Impedance	Ohm		50		At TXRX and ANT Pins
Input Return Loss	dB		-8		At ANT Pin, Low NF Mode
Output Return Loss	dB		-12		At TXRX Pin, Low NF Mode

# BYPASS MODE TECHNICAL PARAMETERS (VDD=3.3V; T=+25 °C):

Parameters	Units	Min	Тур	Мах	Conditions
Operating Frequency	GHz	2.4		2.5	
Insertion Loss	dB		5		
Input P <sub>1dB</sub>	dBm		10		At ANTA or ANTB
Current Consumption	uA		1		Through VDD Supply Pins

# CONTROL LOGIC TRUTH TABLE

TXEN	RXEN	MODE	Mode of Operation
0	0	0	Shutdown Mode
0	0	1	Bypass Mode
1	Х	0	Low Idq TX Mode
1	Х	1	High Idq TX Mode
0	1	0	Low Noise Figure Receive Mode
0	1	1	Low Current Receive Mode

SWant	Mode of Operation
1	ANTA port enabled
0	ANTB port enabled

Note:	"1" denotes	high voltage	state (>	1.2V)
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"0" denotes low voltage stage (<0.3V) at Control Pins

"X" denotes do not care: either "1" or "0" can be applied

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### PCB LAND PATTERN



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#### **RECOMMENDED SOLDER REFLOW PROFILE**



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat/Soak Temperature Min (T <sub>erne</sub> ) Temperature Max (T <sub>ernax</sub> ) Time (t <sub>e</sub> ) from (T <sub>ernen</sub> to T <sub>ernax</sub> )	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )	3 *C/second max.	3 *C/second max.
Liquidous temperature (T <sub>L</sub> ) Time (t <sub>L</sub> ) maintained above T <sub>L</sub>	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T <sub>e</sub> )	For users T <sub>p</sub> must not exceed the Classification temp in Table 4-1.	For users T <sub>p</sub> must not exceed the Classification temp in Table 4-2.
reak package body temperature (1 <sub>p</sub> )	For suppliers T <sub>p</sub> must equal or exceed the Classification temp in Table 4-1.	For suppliers T <sub>p</sub> must equal or exceed the Classification temp in Table 4-2.
Time (t <sub>p</sub> )* within 5 *C of the specified classification temperature (T <sub>p</sub> ), see Figure 5-1.	20* seconds	30* seconds
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 *C/second max.	6 *C/second max.
Time 25 *C to peak temperature	6 minutes max.	8 minutes max.

#### SnPb Eutectic Process - Classification Temperatures (Te)

Package Thickness	Volume mm <sup>8</sup> <350	Volume mm <sup>a</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 *C	220 °C

#### Pb-Free Process - Classification Temperatures (To)

Package Thickness	Volume mm <sup>a</sup> <350	Volume mm <sup>2</sup> 350 - 2000	Volume mm <sup>a</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 *C	245 °C

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